



CERAMIC

Bandpass Filter

BFHK-1072+

Mini-Circuits

50Ω 9.2 to 11.3 GHz

THE BIG DEAL

- Ultra-High Stopband Rejection Structure – 90 dB typical
- Surface mountable pick and place standard case style
- Standard small 1812 (4.5mm x 3.2mm) case style
- High quality distributed filter topology
- Wide rejection band
- Shielded construction preventing filter from de-tuning
- Reduced footprint area by employing LGA (land grid array)
- Suited for very high-volume production
- Patent Pending



Generic photo used for illustration purposes only

CASE STYLE: NM1812C-3

+RoHS Compliant

The +Suffix identifies RoHS Compliance. See our web site for RoHS Compliance methodologies and qualifications

APPLICATIONS

- Test and Measurement
- Aerospace and Defense Signal Conditioning

PRODUCT OVERVIEW

The BFHK-1072+ LTCC Band Pass Filter achieves a miniature size and high repeatability of performance by utilizing a proprietary LTCC material system and distributed filter topology. The passband loss at 9.2 – 11.3 GHz is as low as 3.1 dB, with typical stopband rejections at 90 dB up to 30 GHz. This model handles up to 1W RF input power, and provides a wide operating temperature range from -55 to +125°C. Utilizing a proprietary LTCC material system and a distributed filter topology, this filter is able to achieve repeatable performance on a lot-to-lot basis, up to mmWave frequencies.

KEY FEATURES

Feature	Advantages
Ultra-High Rejection	Typical stopband rejections at 90 dB up to 30 GHz
Cost effective	LTCC is scalable technology that is cost effective due to ease of production in high quantities.
Small size (4.5mm x 3.2mm)	Allows for high layout density of circuit boards, while minimizing effects of parasitics.
Surface Mountable	Suitable for very high volume automated assembly process.

REV. OR
ECO-009365
BFHK-1072+
WY/CP/PS
210910





CERAMIC

Bandpass Filter

BFHK-1072+

ELECTRICAL SPECIFICATIONS¹ AT 25°C

Parameter	F#	Frequency (GHz)		Min.	Typ.	Max.	Units	
Center Frequency	—	—	—	—	10.2	—	GHz	
Pass Band	Insertion Loss	F1-F2	9.2	11.3	—	3.1	4.5	dB
	Return Loss	F1-F2	9.2	11.3	—	12.0	—	dB
Stop Band, Lower	Insertion Loss	DC-F3	2.0	6.0	80	90	—	dB
Stop Band, Upper	Insertion Loss	F4-F5	15.1	30	80	90	—	dB

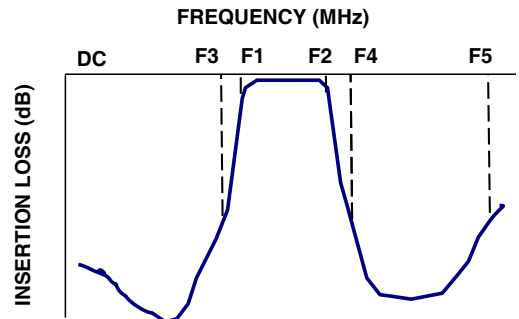
1. Measured on Mini-Circuits Test Board TB-BFHK-1072+ with feedline losses removed by normalization of S12 and S21 traces to measurement of TB thru-line.

MAXIMUM RATINGS

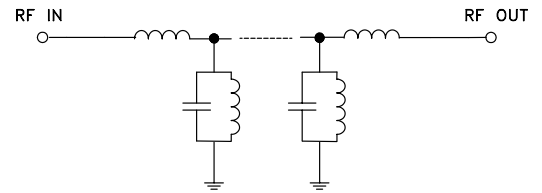
Parameter	Ratings
Operating Temperature	-55°C to 125°C
Storage Temperature	-55°C to 125°C
RF Power Input	1W max.

Permanent damage may occur if any of these limits are exceeded

TYPICAL FREQUENCY RESPONSE



FUNCTIONAL SCHEMATIC



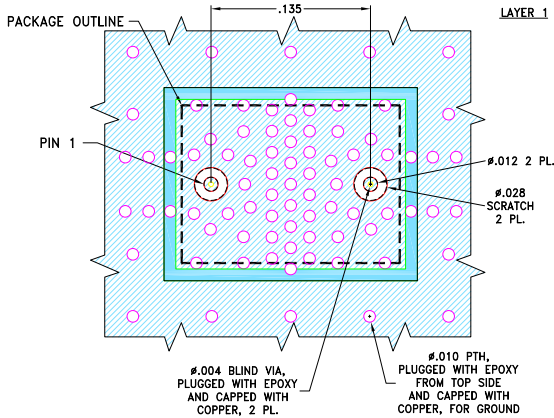


CERAMIC

Bandpass Filter

BFHK-1072+

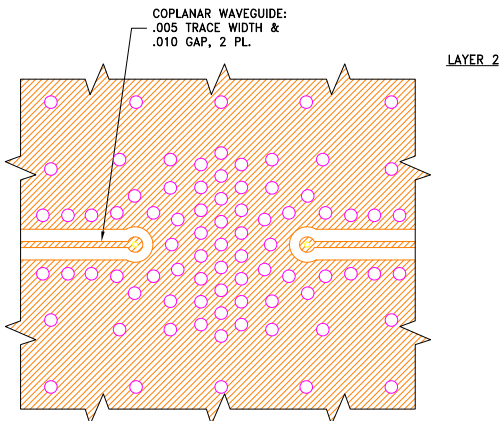
EVALUATION BOARD MCL P/N: TB-BFHK-1072+ SUGGESTED PCB LAYOUT: PL-714



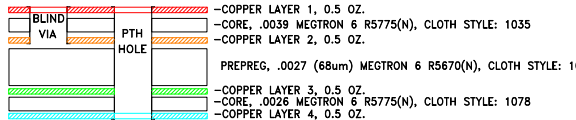
NOTES:

1. PCB IS MULTILAYER PCB, SEE STACK-UP DIAGRAM.
2. TRACE WIDTH & GAP PARAMETERS ARE SHOWN FOR THE SPECIFIED STACKUP. FOR OTHER STACKUPS AND MATERIALS TRACE WIDTH AND GAP MAY NEED TO BE MODIFIED.
3. LAYER 4 OF THE PCB IS CONTINUOUS GROUND PLANE.

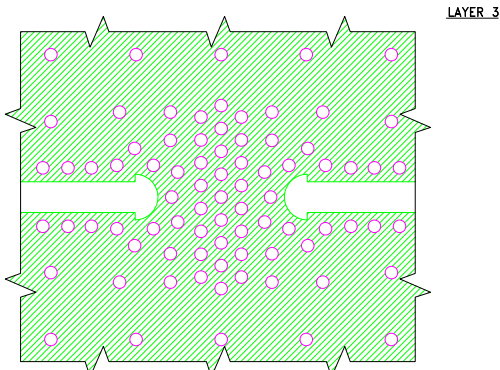
- DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER).
- DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK.



STACK-UP DIAGRAM



1. TOTAL FINISHED THICKNESS $0.015 \pm 10\%$.
2. PTH PRESENT FROM COPPER LAYER 1 TO 4.
3. BLIND VIAS PRESENT FROM COPPER LAYER 1 TO 2.

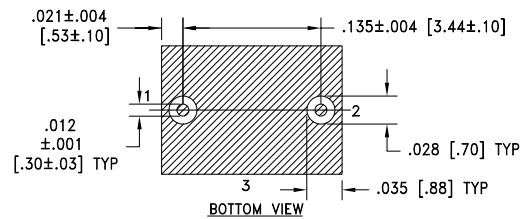
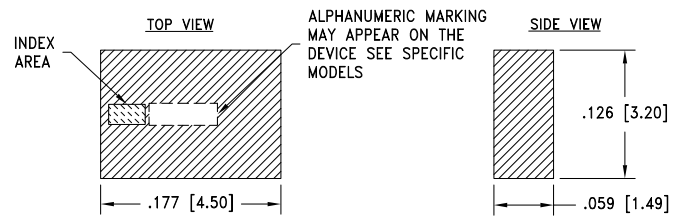


PAD CONNECTIONS

INPUT	1
OUTPUT	2
GROUND	3

PRODUCT MARKING: F442

OUTLINE DRAWING



Weight: .126 grams.

Dimensions are in inches (mm). Tolerances: 2 Pl.±.01; 3 Pl. ±.005



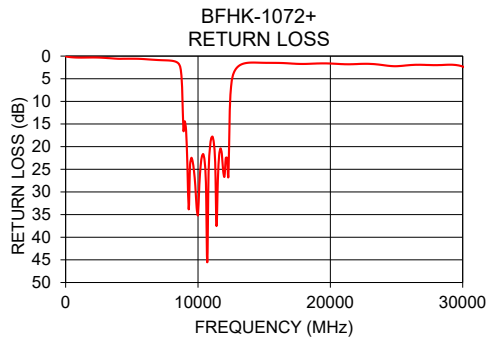
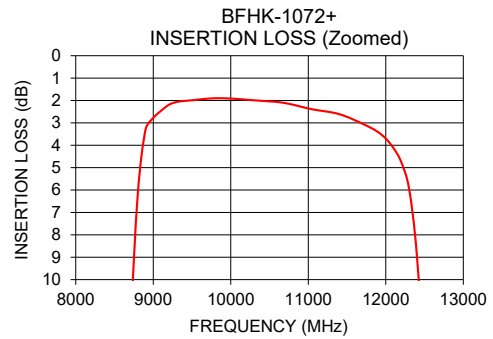
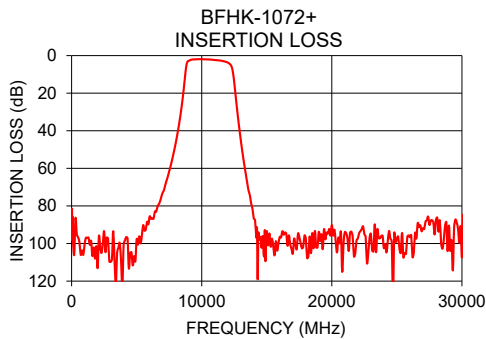
CERAMIC

Bandpass Filter

BFHK-1072+

TYPICAL PERFORMANCE DATA

Frequency (MHz)	Insertion Loss (dB)	Return Loss (dB)
10	82.38	0.07
1000	100.34	0.33
2000	113.16	0.31
3000	109.81	0.40
4000	100.31	0.59
6000	85.53	0.68
7500	61.56	0.93
9200	2.20	24.06
10200	1.96	24.23
10800	2.19	25.56
11300	2.53	23.50
12000	3.70	26.62
14000	86.61	1.44
15000	93.34	1.48
18000	97.22	1.73
22000	97.31	1.76
24000	102.43	2.00
26000	96.61	2.00
28000	87.56	2.00
30000	107.52	2.32



- NOTES**
- A. Performance and quality attributes and conditions not expressly stated in this specification document are intended to be excluded and do not form a part of this specification document.
 - B. Electrical specifications and performance data contained in this specification document are based on Mini-Circuit's applicable established test performance criteria and measurement instructions.
 - C. The parts covered by this specification document are subject to Mini-Circuits standard limited warranty and terms and conditions (collectively, "Standard Terms"); Purchasers of this part are entitled to the rights and benefits contained therein. For a full statement of the standard. Terms and the exclusive rights and remedies thereunder, please visit Mini-Circuits' website at www.minicircuits.com/MCLStore/terms.jsp

